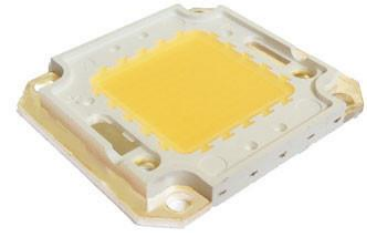


### PRODUCT:

50W CHIP ON BOARD LED

### FEATURES:

46 mm x 40 mm x 3.3 mm chip-on-board LED  
 120° emission angle  
 95 min Ra



### DESCRIPTION

YUJILEDS™ BC400L series high CRI COB provides high CRI, high luminous flux solution. Providing 95 CRI (typical) at 3500 lm, this high-power LED can be used in a variety of applications demanding high color quality and light output.



ELECTRICAL-OPTICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C)							
PARAMETER	SYMBOL	VALUE			UNIT	TOLERANCE	CONDITION
		MIN.	TYP.	MAX.			
Forward voltage	V <sub>f</sub>	28	--	31	V	±0.05	I <sub>f</sub> = 1500mA
Luminous flux	Φ <sub>3200K</sub>	3025	--	3575	lm	--	I <sub>f</sub> = 1500mA
	Φ <sub>5600K</sub>	3190		3740			
Correlated color temperature	CCT <sub>3200K</sub>	3050	3200	3350	K	--	I <sub>f</sub> = 1500mA
	CCT <sub>5600K</sub>	5300	5600	5900			
Color rendering index	R <sub>a</sub>	95	--	--	--	±1	I <sub>f</sub> = 1500mA
TCS R9 (CRI Red)	R <sub>9</sub>	--	70	--	--	--	I <sub>f</sub> = 1500mA
Chromaticity coordinates	(X,Y)	--	--	--	--	±0.005	--
Reverse current	I <sub>r</sub>	--	--	50	μA	±0.1	V <sub>r</sub> = 50V
Viewing angle	2θ <sub>1/2</sub>	--	120	--	Deg	±5	I <sub>f</sub> = 1500mA

ORDERING INFORMATION			
PART NUMBER	EMISSION AREA	CCT	CHROMATICITY BINS
YJ-BC-400HS-G01-32	SQUARE	3200K ± 150K	F4-2, F7-2, F5-1, F8-1
YJ-BC-400HS-G01-56		5600K ± 300K	B8-2, B10-2, C3-1, C5-1
YJ-BC-400HS-G01-XX		CUSTOM	--
YJ-BC-400HC-G01-32	CIRCULAR	3200K ± 150K	F4-2, F7-2, F5-1, F8-1
YJ-BC-400HC-G01-56		5600K ± 300K	B8-2, B10-2, C3-1, C5-1
YJ-BC-400HC-G01-XX		CUSTOM	--

VOLTAGE BIN CODES	
<b>Bin</b>	<b>V28</b>
V <sub>F</sub>	28-31

ABSOLUTE MAXIMUM RATING (T <sub>A</sub> = 25 °C)			
PARAMETER	SYMBOL	LIMIT	UNIT
Power Consumption	P <sub>D</sub>	175	W
DC Forward Current (pulsed)*	I <sub>Fp</sub>	10000**	mA
DC Forward Current	I <sub>F</sub>	5000	mA
Reverse Voltage	V <sub>R</sub>	50	V
Junction Temperature	T <sub>j</sub>	125	°C
Case Temperature***	T <sub>c</sub>	65	°C
Operating Temperature	T <sub>opr</sub>	-30 ~ +80	°C
Storage Temperature	T <sub>stg</sub>	-30 ~ +80	°C
Soldering Temperature	T <sub>sol</sub>	260 ± 5	°C
Reflow Cycles Allowed	--	2	--

\* Pulse width ≤ 0.1ms, Duty ≤ 1/10.

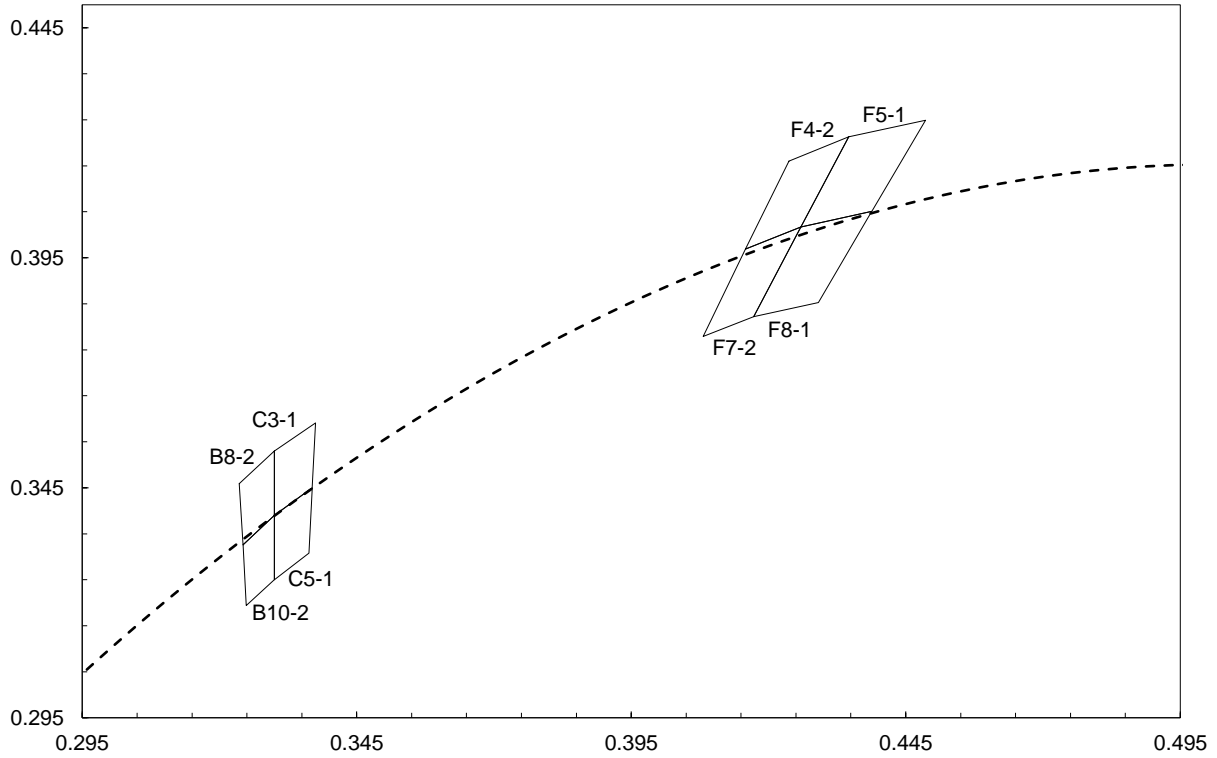
\*\* Theoretical data.

\*\*\* See page 4, 5 for case temperature point definition.

CHROMATICITY BINS & COORDINATES									
CCT	BIN	CIE 1931 COORDINATES							
		X0	Y0	X1	Y1	X2	Y2	X3	Y3
5600K	B8-2	0.3236	0.3459	0.3243	0.3326	0.3300	0.3390	0.3300	0.3530
	B10-2	0.3243	0.3326	0.3249	0.3194	0.3300	0.3250	0.3300	0.3390
	C3-1	0.3300	0.3530	0.3300	0.3390	0.3369	0.3450	0.3375	0.3591
	C5-1	0.3300	0.3390	0.3300	0.3250	0.3363	0.3308	0.3369	0.3450
3200K	F4-2	0.4237	0.4160	0.4158	0.3969	0.4259	0.4017	0.4346	0.4213
	F7-2	0.4158	0.3969	0.4081	0.3779	0.4173	0.3822	0.4259	0.4017
	F5-1	0.4346	0.4213	0.4259	0.4017	0.4388	0.4051	0.4486	0.4249
	F8-1	0.4259	0.4017	0.4173	0.3822	0.4291	0.3853	0.4388	0.4051

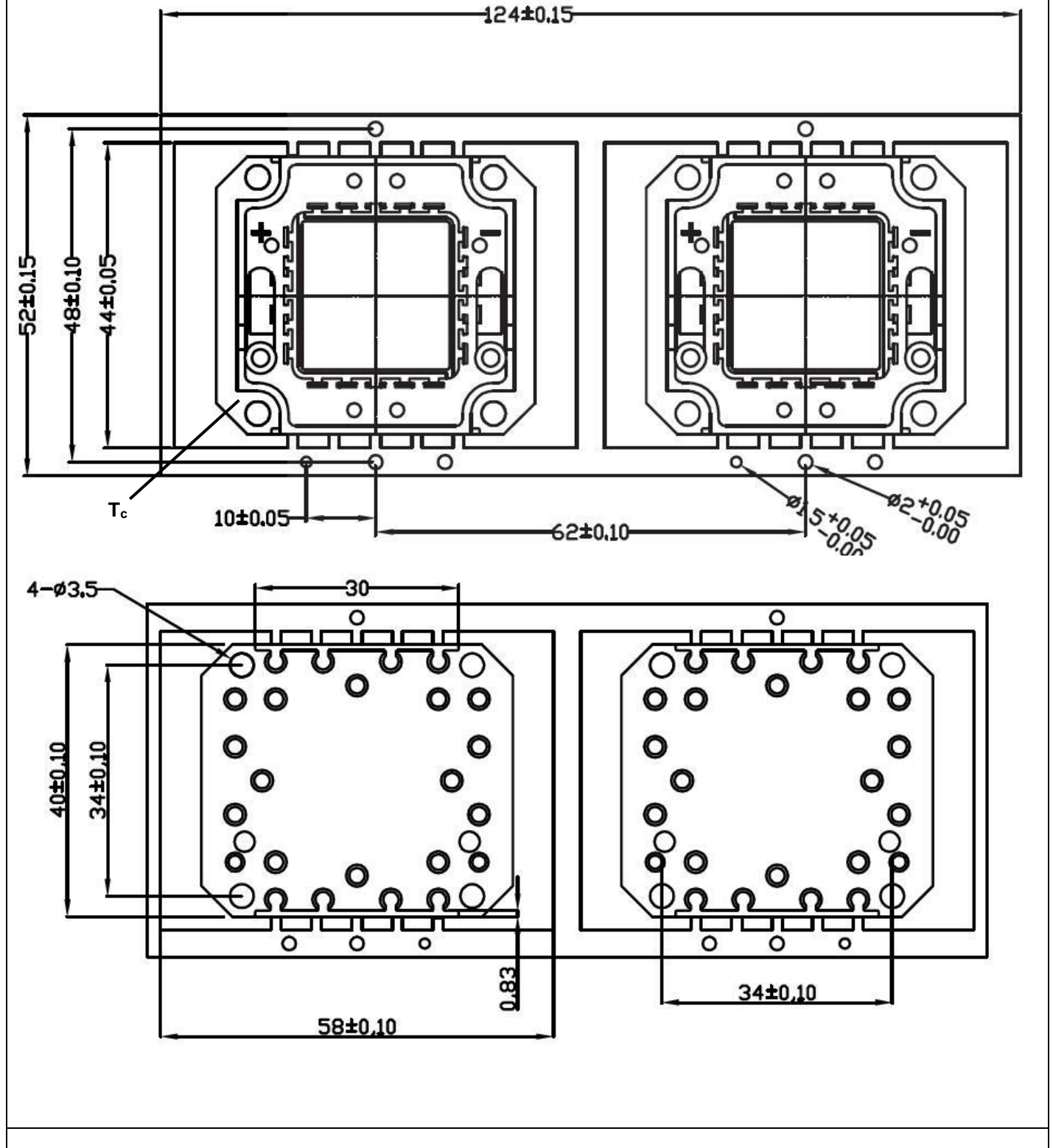
**CHROMATICITY BINS & COORDINATES**

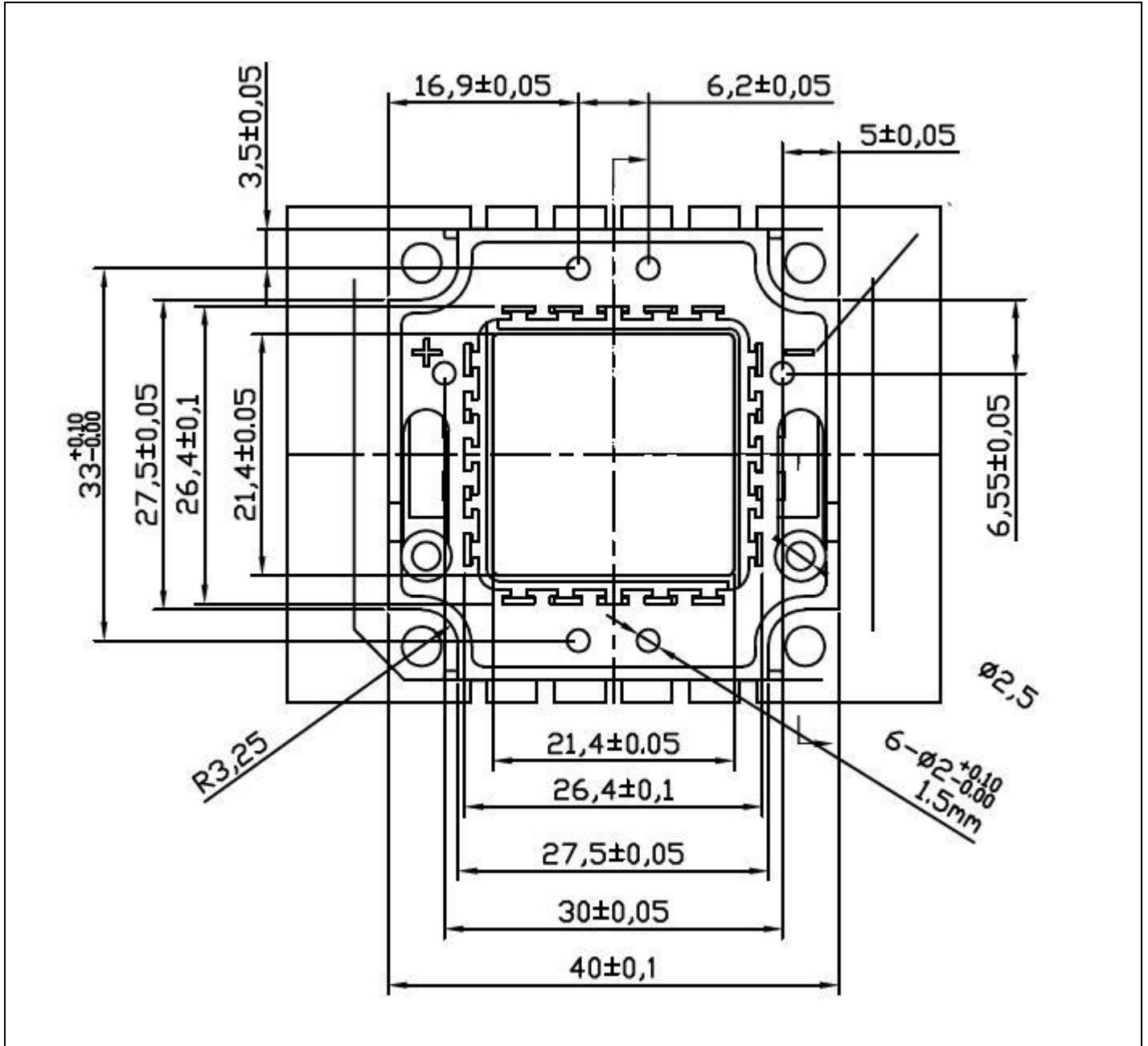
**CIE 1931 COORDINATES**

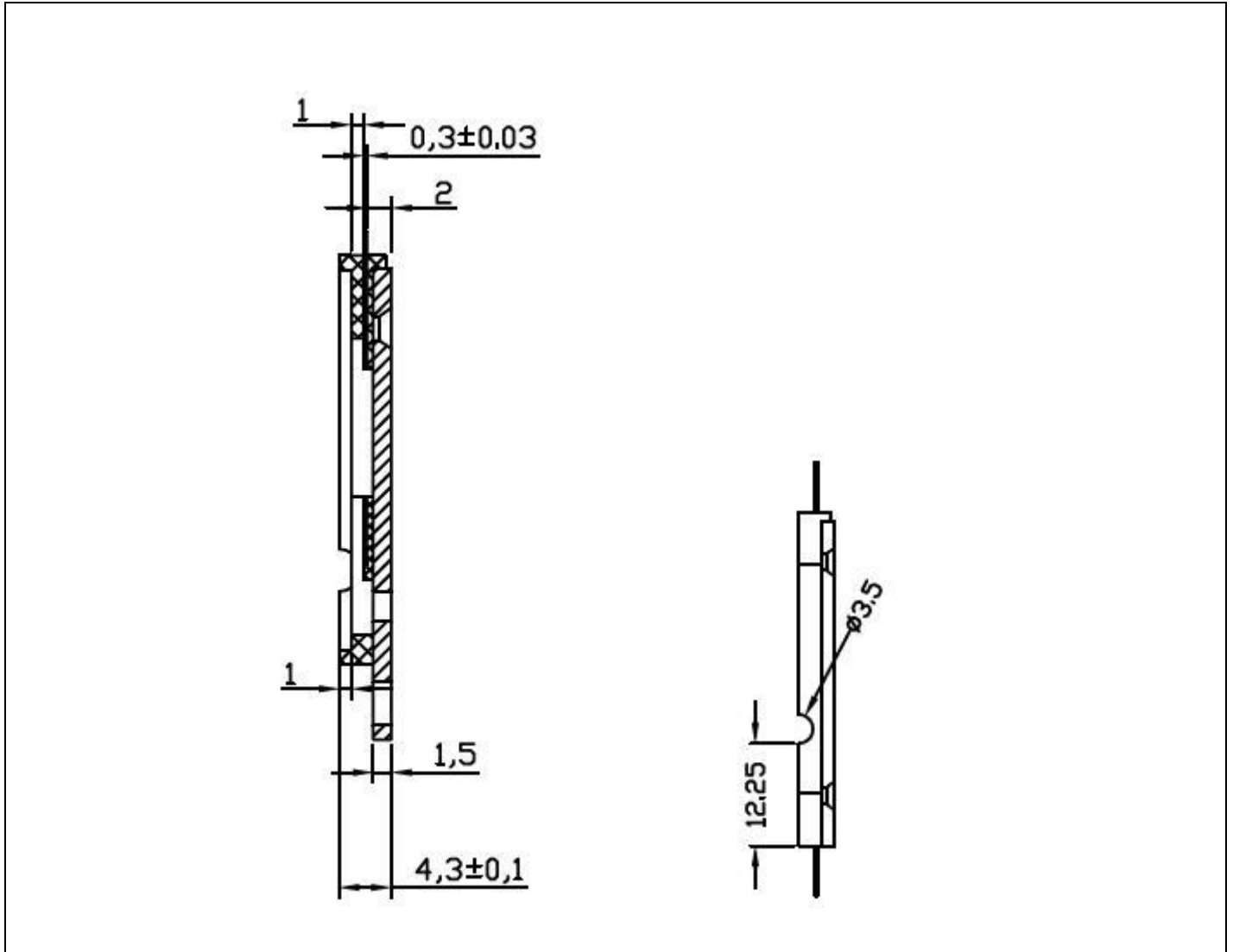


**PACKAGE LAYOUT – SQUARE EMISSION MODEL**

All dimensions in mm, tolerance unless mentioned is  $\pm 0.1$ mm.





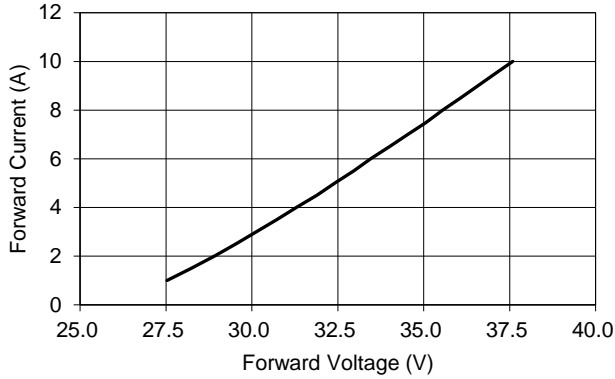


PACKAGE MATERIALS	
ITEM	DESCRIPTION
DIE MATERIAL	InGaN
LEAD FRAME MATERIAL	COPPER ALLOY
ENCAPSULANT RESIN MATERIAL	SILICONE + PHOSPHOR
ELECTRODES MATERIAL	COPPER + SILVER ALLOY

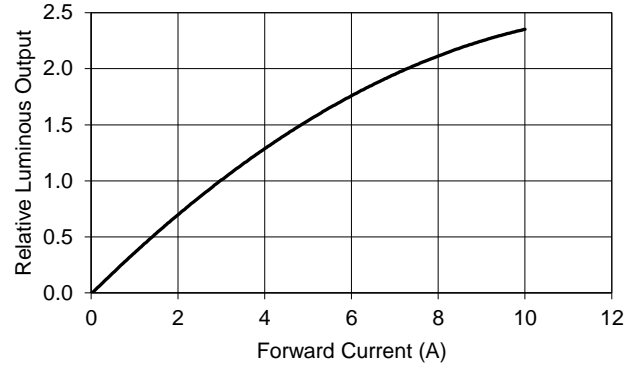
### CHARACTERISTIC CURVES

ALL CHARACTERISTIC CURVES ARE FOR REFERENCE ONLY AND NOT GUARANTEED

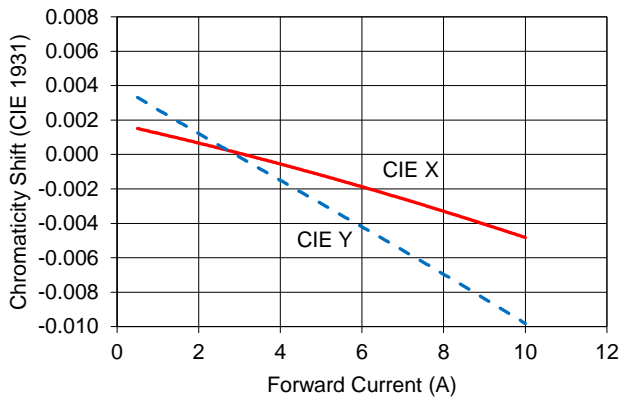
FORWARD CURRENT VS FORWARD VOLTAGE ( $T_A = 25^\circ\text{C}$ )



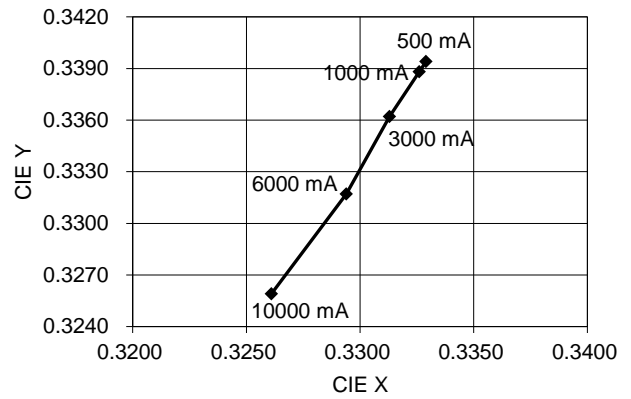
FORWARD CURRENT VS RELATIVE LUMINOUS OUTPUT ( $T_A = 25^\circ\text{C}$ )



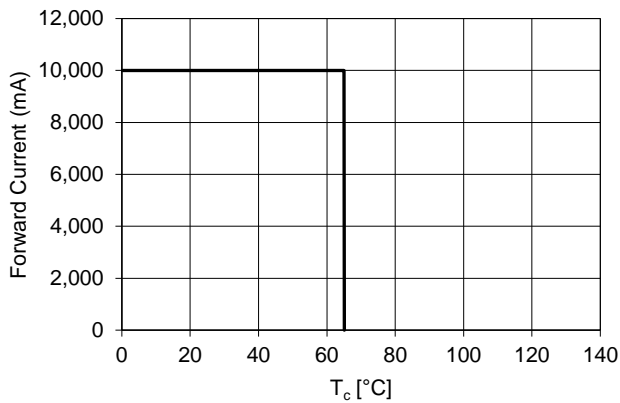
FORWARD CURRENT VS CHROMATICITY SHIFT (5600K,  $T_A = 25^\circ\text{C}$ )



FORWARD CURRENT VS CHROMATICITY SHIFT (5600K,  $T_A = 25^\circ\text{C}$ )

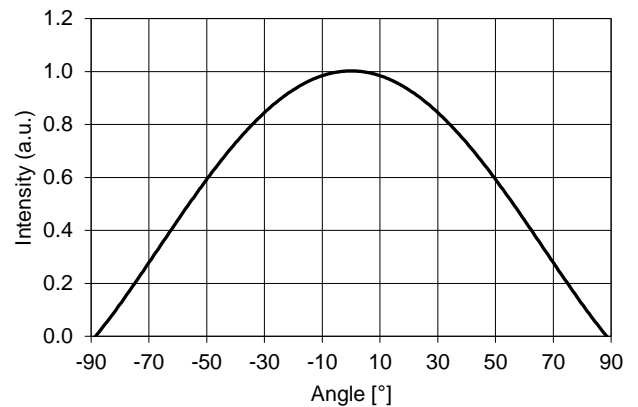


FORWARD CURRENT DERATING BASED ON CASE TEMPERATURE

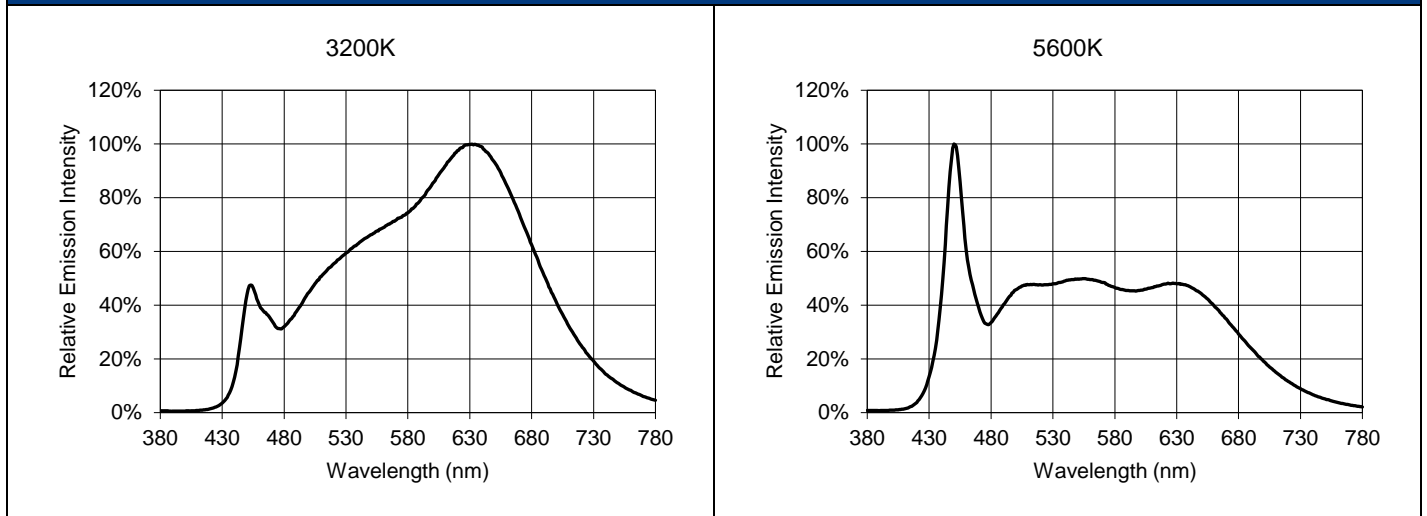


NOTE: DE-RATING CURVES ARE MEANT FOR RECOMMENDATION ONLY AND ARE NOT MEANT TO PROVIDE GUARANTEES OF PRODUCT STABILITY AND LONGEVITY

TYPICAL SPATIAL DISTRIBUTION ( $T_A = 25^\circ\text{C}$ ,  $I_f = 3000\text{ mA}$ )



**TYPICAL SPECTRAL DISTRIBUTION GRAPHS**



**LOT NUMBERING SCHEME**

Yuji LED uses two formats for lot numbering purposes:

1) YYYY-MM-XXX-Z

YYYY: 4-digit manufacturing year  
 MM: 2-digit manufacturing month  
 XXX: 3-digit inventory number (000 – 999)  
 Z: internal alphanumeric code

2) YYYYMMXXX

YYYY: 4-digit manufacturing year  
 MM: 2-digit manufacturing month  
 XXX: 3-digit inventory number (000 – 999)